CEP6030LS2/CEB6030LS2

ELECTRICAL CHARACTERISTICS (Tc=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV_{DSS}	V_{GS}=0V, I_D=250μA	30			V
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS}=24V, V_{GS} =0V			10	μA
Gate-Body Leakage	I_{GSS}	V_{GS} =±16V, V_{DS}=0V			±100	nA
ON CHARACTERISTICS[a]						
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS}=V_{GS}, I_D = 250μA	1	1.6	3	V
Drain-Source On-State Resistance	$R_{DS(ON)}$	V_{GS} = 10V, I_D = 26A		11	13.5	mΩ
		V_{GS} = 4.5V, I_D = 21A		16	20.0	mΩ
On-State Drain Current	$I_{D(ON)}$	V_{GS} = 10V, V_{DS} = 10V	60			A
Forward Transconductance	g_{FS}	V_{DS} = 10V, I_D = 26A		32		S
DYNAMIC CHARACTERISTICS[b]						
Input Capacitance	C_{ISS}	V_{DS} =15V, V_{GS} = 0V f =1.0MHz		1920	2500	pF
Output Capacitance	C_{OSS}			960	1250	pF
Reverse Transfer Capacitance	C_{RSS}			300	400	pF
SWITCHING CHARACTERISTICS[b]						
Turn-On Delay Time	$t_{D(ON)}$	V_{DD} = 15V, I_D = 52A, V_{GEN}= 10V, R_{GEN} =24Ω		10	16	ns
Rise Time	t_r			190	250	ns
Turn-Off Delay Time	$t_{D(OFF)}$			55	90	ns
Fall Time	t_f			130	200	ns
Total Gate Charge	Q_g	V_{DS} =10V, I_D = 52A, V_{GS} =10V		35	60	nC
Gate-Source Charge	Q_{gs}			8		nC
Gate-Drain Charge	Q_{gd}			5		nC

BODY DIODE & SCHOTTKY DIODE RATINGS AND CHARACTERISTICS

Parameter	Symbol	Condition	Min	Typ	Max	Unit
DRAIN-SOURCE DIODE CHARACTERISTICS [a]						
Body Diode Forward Voltage	V_{SD}	V_{GS} = 0V, I_S =26A		0.93	1.3	V
Schottky Forward Voltage	V_F	I_F=2A, T_C=25°C			0.55	V
Average Forward Rectified Current	$I_{F(AV)}$				2	A

Notes

a.Pulse Test:Pulse Width ≤300 μs, Duty Cycle ≤ 2%.

b.Guaranteed by design, not subject to production testing.

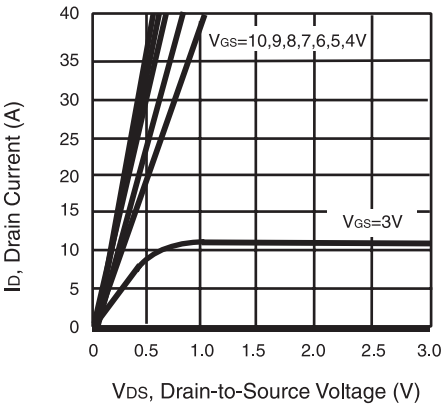

Figure 1. Output Characteristics

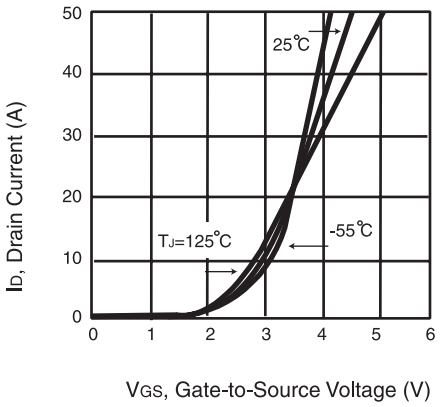

Figure 2. Transfer Characteristics

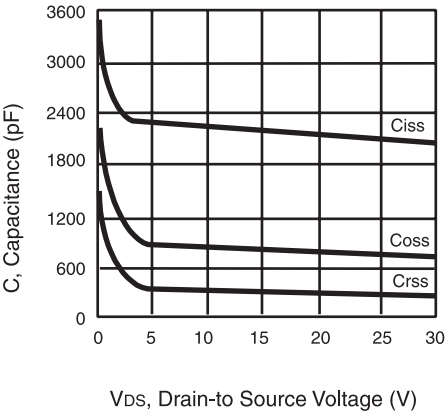

Figure 3. Capacitance

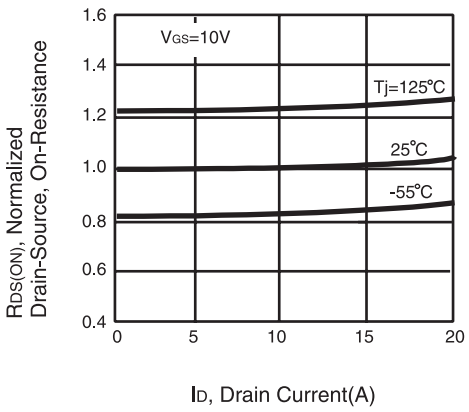

Figure 4. On-Resistance Variation with Drain Current and Temperature

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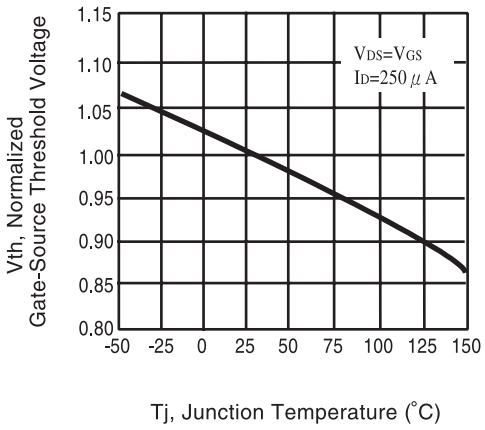


Figure 5. Gate Threshold Variation with Temperature

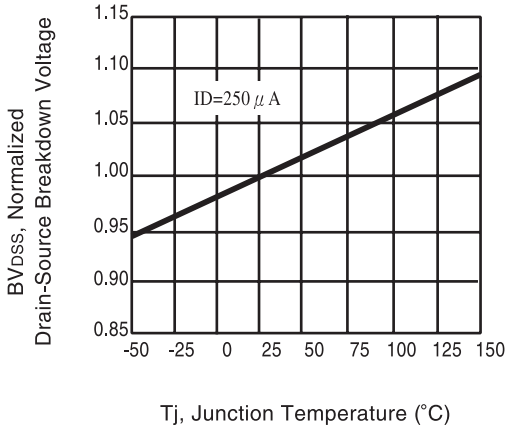


Figure 6. Breakdown Voltage Variation with Temperature

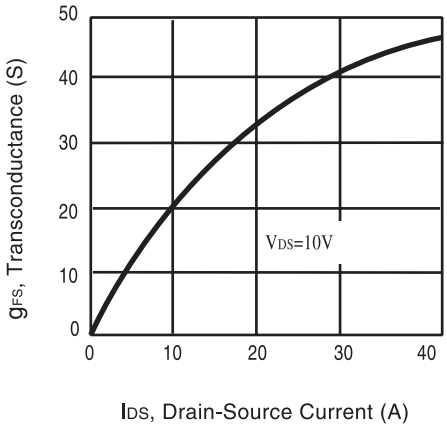


Figure 7. Transconductance Variation with Drain Current

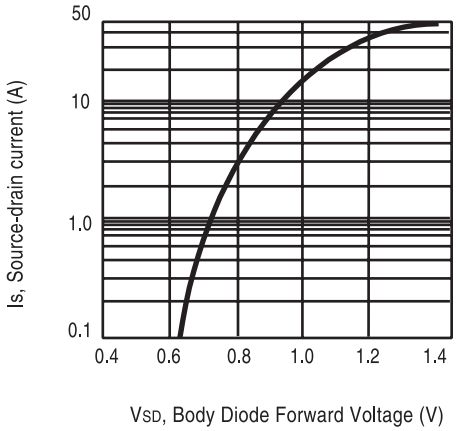


Figure 8. Body Diode Forward Voltage Variation with Source Current

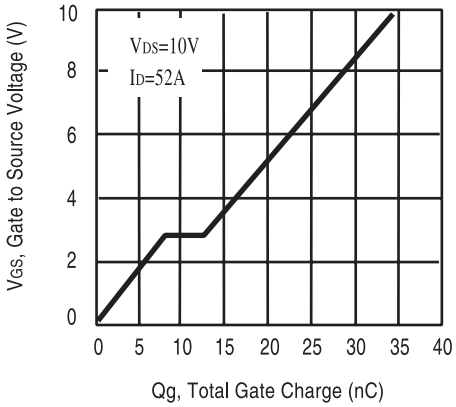


Figure 9. Gate Charge

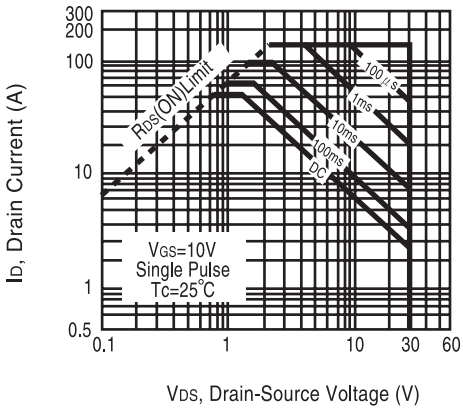


Figure 10. Maximum Safe Operating Area

15

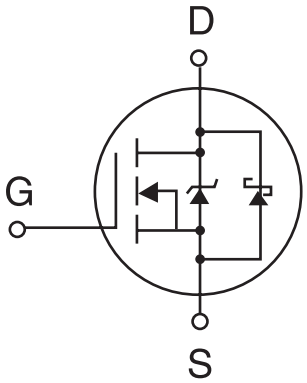
CEP6030LS2/CEB6030LS2

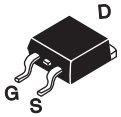
PRELIMINARY

N-Channel Logic Level Enhancement Mode Field Effect Transistor

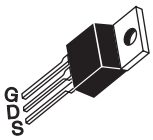
FEATURES

- 30V , 52A , $R_{DS(ON)}$=13.5mΩ @V_{GS}=10V.
  $R_{DS(ON)}$=20mΩ @V_{GS}=4.5V.
- Super high dense cell design for extremely low $R_{DS(ON)}$.
- High power and current handling capability.
- TO-220 & TO-263 package.





CEB SERIES
TO-263(DD-PAK)



CEP SERIES
TO-220

ABSOLUTE MAXIMUM RATINGS (Tc=25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V_{DS}	30	V
Gate-Source Voltage	V_{GS}	±20	V
Drain Current-Continuous	I_D	52	A
-Pulsed	I_{DM}	156	A
Drain-Source Diode Forward Current	I_S	52	A
Maximum Power Dissipation @Tc=25°C	P_D	50	W
Derate above 25°C		0.4	W/°C
Operating and Storage Temperature Range	T_J, T_{STG}	-65 to 175	°C

THERMAL CHARACTERISTICS

Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	2.5	°C/W
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	62.5	°C/W

15

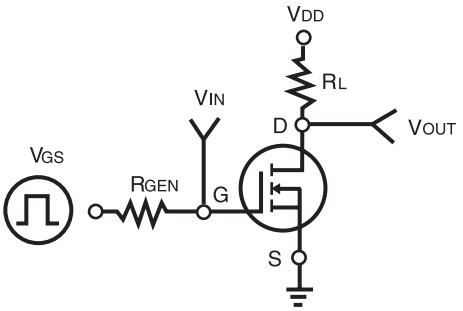


Figure 11. Switching Test Circuit

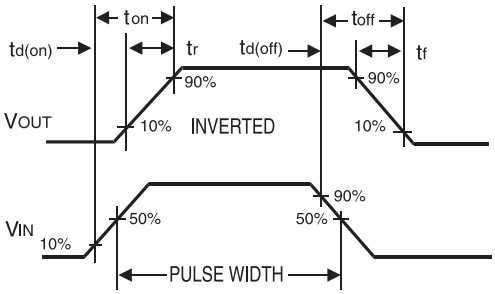


Figure 12. Switching Waveforms

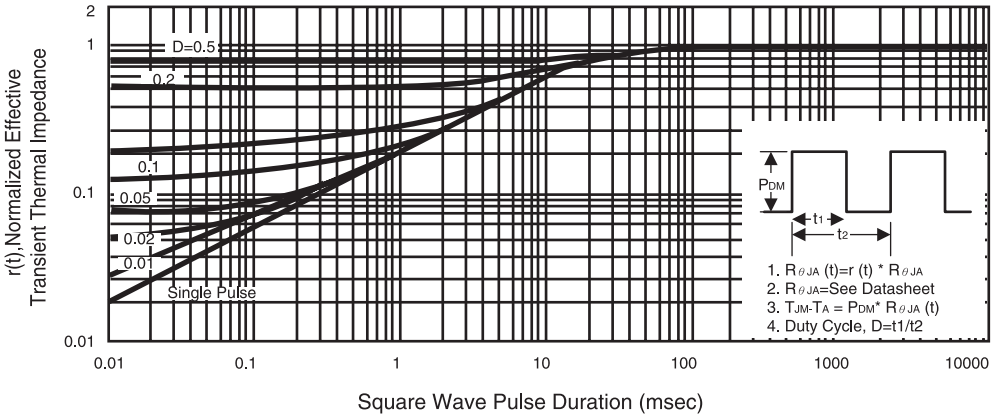


Figure 13. Normalized Thermal Transient Impedance Curve